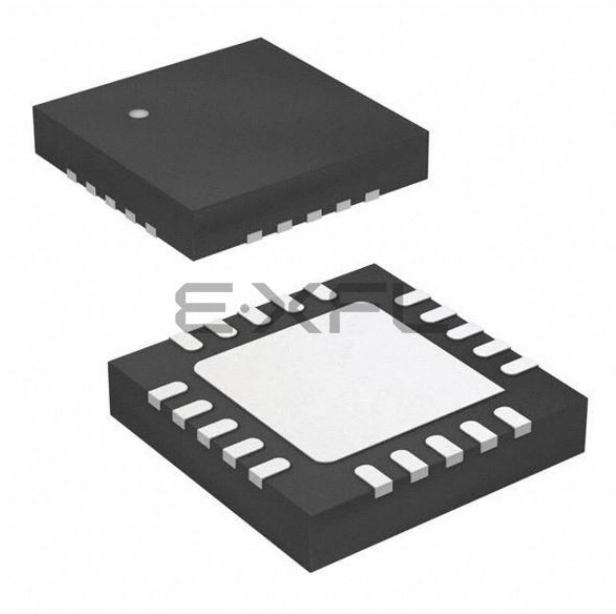
Zilog - Z8F0831QH020EG Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	17
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	20-VQFN Exposed Pad
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0831qh020eg

Revision History

Each instance in this document's revision history reflects a change from its previous edition. For more details, refer to the corresponding page(s) or appropriate links furnished in the table below.

Date	Revision Level	Chapter/Section	Description	Page No.
Dec 2012	13	GPIO	Modified GPIO Port D0 language in Shared Reset Pin section and Port Alternate Function Mapping table.	35, 36
Sep 2011	12	LED Drive Enable Register	Clarified statement surrounding the Alternate Function Register as it relates to the LED function; revised Sector Based Flash Protection description; revised Packaging chapter.	51, 115, 199
Dec 2007	11	n/a	Updated all instances of *Z8 Encore! XP F0830* to *Z8 Encore! F0830*.	All
Nov 2007	10	DC Characteristics, On-Chip Peripheral AC and DC Electrical Characteristics	Updated Tables 116 and and 122.	185, 193
Sep 2007	09	Timers, PWM SINGLE OUTPUT Mode, PWM DUAL OUTPUT Mode, Analog-to-Digital Converter, Reference Buffer.	Updated Figures 2 and 4, Table 4.	8, 9, 11, 68, 74, 75, 98, 101
Apr 2007	08	Optimizing NVDS Memory Usage for Execution Speed, On-Chip Peripheral AC and DC Electrical Characteristics	Added a note under Table 93 in Nonvolatile Data Storage chapter. Updated Table 121 and Table 122 in Electrical Characteristics chapter. Other style updates.	137, 193, 193
Dec 2006	07	General Purpose Input/Output	Added PD0 in Table 16.	38
		Overview, Interrupt Controller	Changed the number of interrupts to 17.	1,5, 53
		Nonvolatile Data Storage	Updated chapter.	136
		Oscillator Control Register Definitions, AC Characteristics, On-Chip Peripheral AC and DC Electrical Characteristics	Updated Tables 117 and 122. Added Figure 24.	156, 189, 193
		Ordering Information	Updated Part Number Suffix Designations.	205
		n/a	Removed *Preliminary* stamp from footer.	All

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
Analog-to-Digital Converter (ADC, cont'd)				
F73	ADC data low bits	ADCD_L	XX	103
F74	ADC sample settling time	ADCSST	0F	104
F75	ADC sample time	ADCST	3F	105
F76	Reserved	—	XX	
F77–F7F	Reserved	—	XX	
Low Power Control				
F80	Power control 0	PWRCTL0	88	32
F81	Reserved	—	XX	
LED Controller				
F82	LED drive enable	LEDEN	00	51
F83	LED drive level high	LEDLVLH	00	51
F84	LED drive level low	LEDLVLL	00	52
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator control	OSCCTL	A0	154
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 control	CMP0	14	107
F91–FBF	Reserved	—	XX	
Interrupt Controller				
FC0	Interrupt request 0	IRQ0	00	58
FC1	IRQ0 enable high bit	IRQ0ENH	00	61
FC2	IRQ0 enable low Bit	IRQ0ENL	00	61
FC3	Interrupt request 1	IRQ1	00	59
FC4	IRQ1 enable high bit	IRQ1ENH	00	62
FC5	IRQ1 enable low bit	IRQ1ENL	00	63
FC6	Interrupt request 2	IRQ2	00	60
FC7	IRQ2 enable high bit	IRQ2ENH	00	64
FC8	IRQ2 enable low bit	IRQ2ENL	00	64
FC9–FCC	Reserved	—	XX	
FCD	Interrupt edge select	IRQES	00	66

Note: XX = Undefined.

Low-Power Modes

The Z8 Encore! F0830 Series products contain power saving features. The highest level of power reduction is provided by the STOP Mode. The next level of power reduction is provided by the HALT Mode.

Further power savings can be implemented by disabling the individual peripheral blocks while in NORMAL Mode.

The user must not enable the pull-up register bits for unused GPIO pins, since these ports are default output to VSS. Unused GPIOs include those missing on 20-pin packages, as well as those missing on the ADC-enabled 28-pin packages.

STOP Mode

Executing the eZ8 CPU's STOP instruction places the device into STOP Mode. In STOP Mode, the operating characteristics are:

- Primary crystal oscillator and Internal Precision Oscillator are stopped; XIN and XOUT (if previously enabled) are disabled and PA0/PA1 revert to the states programmed by the GPIO registers
- System clock is stopped
- eZ8 CPU is stopped
- Program counter (PC) stops incrementing
- Watchdog Timer's internal RC oscillator continues to operate if enabled by the Oscillator Control Register
- If enabled, the Watchdog Timer logic continues to operate
- If enabled for operation in STOP Mode by the associated Flash option bit, the Voltage Brown-Out protection circuit continues to operate
- All other on-chip peripherals are idle

To minimize the current in STOP Mode, all GPIO pins that are configured as digital inputs must be driven to V_{DD} when the pull-up register bit is enabled or to one of power rail (V_{DD} or GND) when the pull-up register bit is disabled. The device can be brought out of STOP Mode using Stop Mode Recovery. For more information about Stop Mode Recovery, see *the* Reset and Stop Mode Recovery *chapter on page 21*.

Table 16. Port Alternate Function Mapping (Continued)

Port	Pin	Mnemonic	Alternate Function Description	Alternate Function Set Register AFS1
Port C[3]	PC0	Reserved		AFS1[0]: 0
		ANA4/CINP	ADC or comparator input	AFS1[0]: 1
	PC1	Reserved		AFS1[1]: 0
		ANA5/CINN	ADC or comparator input	AFS1[1]: 1
	PC2	Reserved		AFS1[2]: 0
		ANA6	ADC analog input	AFS1[2]: 1
	PC3	COUT	Comparator output	AFS1[3]: 0
		Reserved		AFS1[3]: 1
	PC4	Reserved		AFS1[4]: 0
				AFS1[4]: 1
	PC5	Reserved		AFS1[5]: 0
				AFS1[5]: 1
	PC6	Reserved		AFS1[6]: 0
				AFS1[6]: 1
	PC7	Reserved		AFS1[7]: 0
				AFS1[7]: 1
Port D[1]	PD0	RESET	Default to be Reset function	N/A

Notes:
1. Because there is only a single alternate function for each Port A and Port D (PD0) pin, the Alternate Function Set registers are not implemented for Port A and Port D (PD0). Enabling alternate function selections (as described in the Port A–D Alternate Function Subregisters section on page 42) automatically enables the associated alternate function.
2. Because there are at most two choices of alternate functions for any Port B pin, the AFS2 Alternate Function Set Register is implemented but is not used to select the function. Additionally, alternate function selection (as described in the Port A–D Alternate Function Subregisters section on page 42) must also be enabled.
3. Because there are at most two choices of alternate functions for any Port C pin, the AFS2 Alternate Function Set Register is implemented but is not used to select the function. Additionally, alternate function selection (as described in the Port A–D Alternate Function Subregisters section on page 42) must also be enabled.

Port A–D Output Control Subregisters

The Port A–D Output Control Subregister, shown in Table 23, is accessed through the Port A–D Control Register by writing 03H to the Port A–D Address Register. Setting the bits in the Port A–D Output Control subregisters to 1 configures the specified port pins for open-drain operation. These subregisters affect the pins directly and, as a result, alternate functions are also affected.

Table 23. Port A–D Output Control Subregisters (PxOC)

Bit	7	6	5	4	3	2	1	0
Field	POC7	POC6	POC5	POC4	POC3	POC2	POC1	POC0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 03H in Port A–D Address Register, accessible through the Port A–D Control Register							

Bit	Description
[7:0] POCx	**Port Output Control** These bits function independently of the Alternate function bit and always disable the drains, if set to 1. 0 = The drains are enabled for any OUTPUT Mode (unless overridden by the Alternate function). 1 = The drain of the associated pin is disabled (OPEN-DRAIN mode).

Note: x indicates the specific GPIO port pin number (7–0).

3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. Clear the timer PWM High and Low Byte registers to 0000H. This allows user software to determine if interrupts are generated by either a capture event or a reload. If the PWM High and Low Byte registers still contain 0000H after the interrupt, the interrupt were generated by a reload.
5. Enable the timer interrupt, if appropriate and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and Reload events. The user can configure the timer interrupt to be generated only at the input capture event or the reload event by setting the TICONFIG field of the TxCTL1 Register.
6. Configure the associated GPIO port pin for the timer input alternate function.
7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time between the timer start and the capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

COMPARE Mode

In COMPARE Mode, the timer counts up to 16-bit maximum compare value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the compare value, the timer generates an interrupt and counting continues (the timer value is not reset to 0001H). Additionally, if the timer output alternate function is enabled, the timer output pin changes state (from Low to High or from High to Low) upon compare.

If the timer reaches FFFFH, the timer resets to 0000H and continues counting.

Observe the following steps for configuring a timer for COMPARE Mode and for initiating the count:

1. Write to the Timer Control Register to:
   - Disable the timer
   - Configure the timer for COMPARE Mode
   - Set the prescale value
   - Set the initial logic level (High or Low) for the timer output alternate function
2. Write to the Timer High and Low Byte registers to set the starting count value.
3. Write to the Timer Reload High and Low Byte registers to set the compare value.

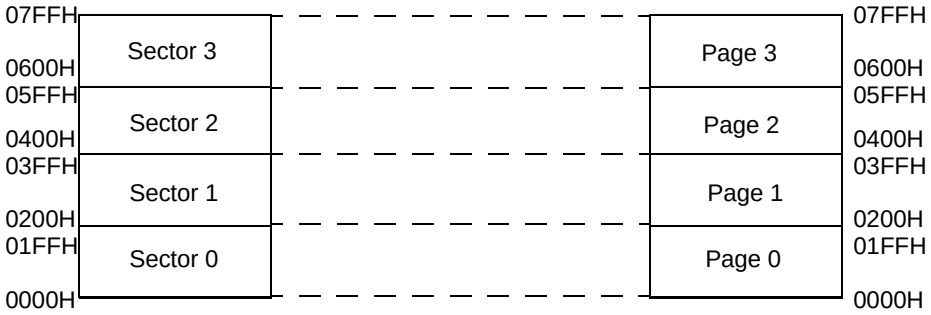

Figure 15. 2K Flash with NVDS

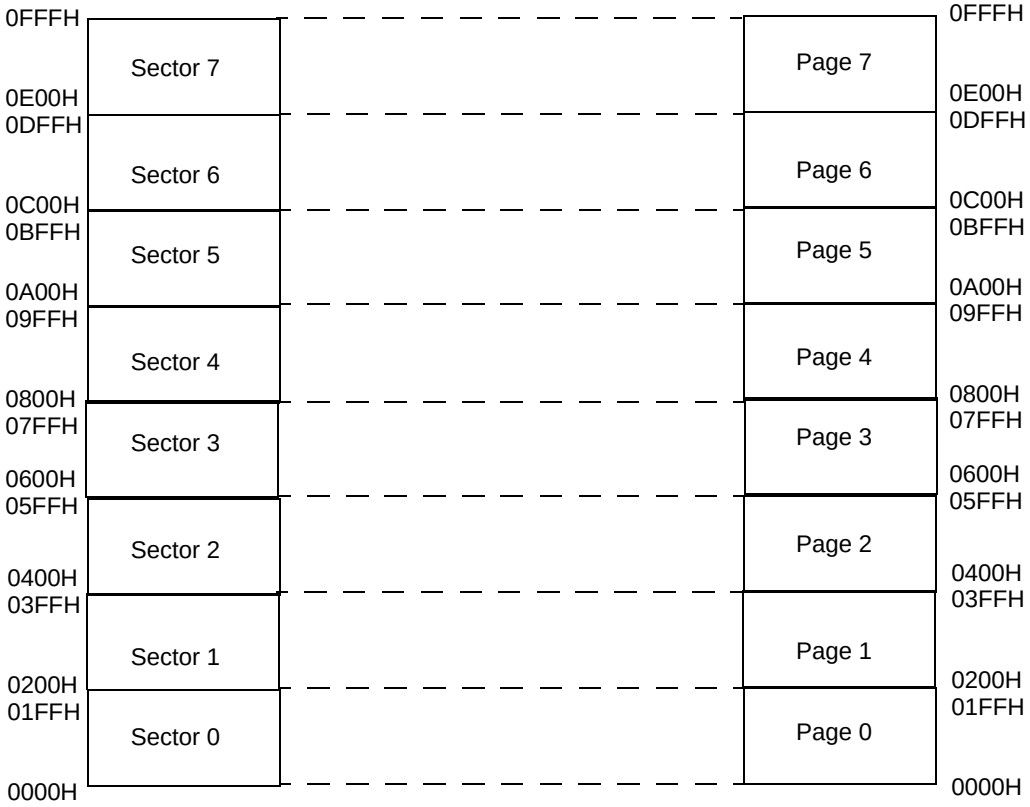

Figure 16. 4K Flash with NVDS

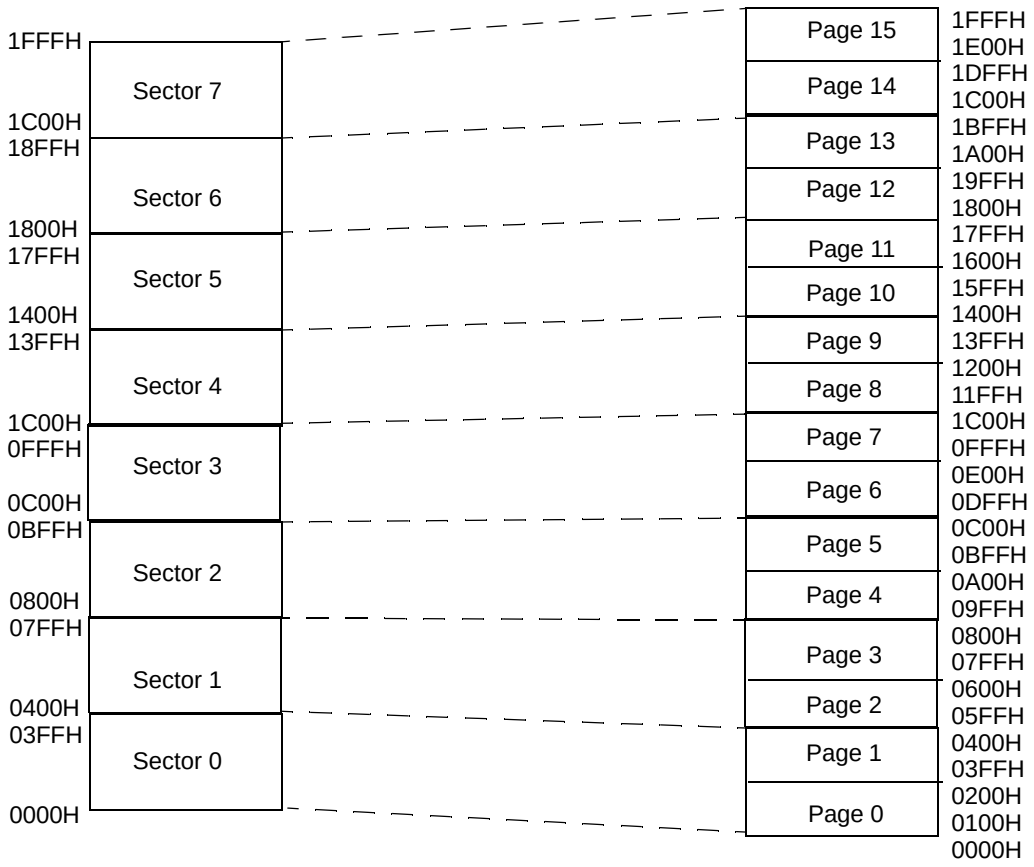

Figure 17. 8K Flash with NVDS

Flash Operation Timing Using the Flash Frequency Registers

Before performing either a Program or Erase operation on Flash memory, the user must first configure the Flash Frequency High and Low Byte registers. The Flash frequency registers allow programming and erasing of the Flash with system clock frequencies ranging from 10kHz to 20MHz.

The Flash Frequency High and Low Byte registers combine to form a 16-bit value, FFREQ, to control the timing for Flash Program and Erase operations. The 16-bit binary Flash frequency value must contain the system clock frequency (in kHz). This value is calculated using the following equation:

$$FFREQ[15:0] = \frac{\text{System Clock Frequency (Hz)}}{1000}$$

Caution: Flash programming and erasure are not supported for system clock frequencies below 10kHz or above 20MHz. The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure operation of the Z8 Encore! F0830 Series devices.

Flash Code Protection Against External Access

The user code contained within Flash memory can be protected against external access by using the On-Chip Debugger. Programming the FRP Flash option bit prevents reading of the user code using the On-Chip Debugger. For more information, see the Flash Option Bits chapter on page 124 and the On-Chip Debugger chapter on page 139.

Flash Code Protection Against Accidental Program and Erasure

The Z8 Encore! F0830 Series provides several levels of protection against accidental program and erasure of the Flash memory contents. This protection is provided by a combination of the Flash option bits, the register locking mechanism, the page select redundancy and the sector level protection control of the Flash Controller.

Flash Code Protection Using the Flash Option Bits

The FHSWP and FWP Flash option bits combine to provide three levels of Flash program memory protection, as listed in Table 71. See the Flash Option Bits chapter on page 124 for more information.

Nonvolatile Data Storage

Z8 Encore! F0830 Series devices contain a Nonvolatile Data Storage (NVDS) element of up to 64 bytes (except when in Flash 12KB mode). This type of memory can perform over 100,000 write cycles.

Operation

NVDS is implemented by special-purpose Zilog software stored in areas of program memory that are not user-accessible. These special-purpose routines use Flash memory to store the data, and incorporate a dynamic addressing scheme to maximize the write/erase endurance of the Flash.

Note: The products in the Z8 Encore! F0830 Series feature multiple NVDS array sizes. See the Z8 Encore! F0830 Series Family Part Selection Guide section on page 2 for details.

NVDS Code Interface

Two routines are required to access the NVDS: a write routine and a read routine. Both of these routines are accessed with a `CALL` instruction to a predefined address outside of program memory that is accessible to the user. Both the NVDS address and data are single-byte values. In order to not disturb the user code, these routines save the working register set before using it so that 16 bytes of stack space are required to preserve the site. After finishing the call to these routines, the working register set of the user code is recovered.

During both read and write accesses to the NVDS, interrupt service is not disabled. Any interrupts that occur during NVDS execution must not disturb the working register and existing stack contents; otherwise, the array can become corrupted. Zilog recommends the user disable interrupts before executing NVDS operations.

Use of the NVDS requires 16 bytes of available stack space. The contents of the working register set are saved before calling NVDS read or write routines.

For correct NVDS operation, the Flash Frequency registers must be programmed based on the system clock frequency. See *the* Flash Operation Timing Using the Flash Frequency Registers *section on page 114*.

Crystal Oscillator

The products in the Z8 Encore! F0830 Series contain an on-chip crystal oscillator for use with external crystals with 32kHz to 20MHz frequencies. In addition, the oscillator supports external RC networks with oscillation frequencies up to 4MHz or ceramic resonators with frequencies up to 8MHz. The on-chip crystal oscillator can be used to generate the primary system clock for the internal eZ8 CPU and the majority of its on-chip peripherals. Alternatively, the X_{IN} input pin can also accept a CMOS-level clock input signal (32kHz–20MHz). If an external clock generator is used, the X_{OUT} pin must remain unconnected. The on-chip crystal oscillator also contains a clock filter function. To see the settings for this clock filter, see Table 90 on page 133. By default, however, this clock filter is disabled; therefore, no divide to the input clock (namely, the frequency of the signal on the X_{IN} input pin) can determine the frequency of the system clock when using the default settings.

Note: Although the X_{IN} pin can be used as an input for an external clock generator, the CLKIN pin is better suited for such use. See *the* System Clock Selection *section on page 151* for more information.

Operating Modes

The Z8 Encore! F0830 Series products support the following four OSCILLATOR Modes:

- Minimum power for use with very low frequency crystals (32kHz to 1MHz)
- Medium power for use with medium frequency crystals or ceramic resonators (0.5MHz to 8MHz)
- Maximum power for use with high frequency crystals (8MHz to 20MHz)
- On-chip oscillator configured for use with external RC networks (<4MHz)

The OSCILLATOR Mode is selected using user-programmable Flash option bits. See the Flash Option Bits chapter on page 124 for more information.

Crystal Oscillator Operation

The XTLDIS Flash option bit controls whether the crystal oscillator is enabled during reset. The crystal may later be disabled after reset if a new oscillator has been selected as the system clock. If the crystal is manually enabled after reset through the OSCCTL Reg-

Upper Nibble (Hex) \ Lower Nibble (Hex)	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0																
1																
2																
3																
4																
5																
6																
7	3.2 PUS															
8																
9																
A			3.3 **CPC** r1,r2	3.4 **CPC** r1,Ir2	4.3 **CPC** R2,R1	4.4 **CPC** IR2,R1	4.3 **CPC** R1,IM	4.4 **CPC** IR1,IM	5.3 **CPCX** ER2,ER1	5.3 **CPCX** IM,ER1						
B																
C	3.2 **SRL** R1	3.3 **SRL** IR1														
D																
E									5, 4 **LDWX** ER2,ER1							
F																

Figure 30. Second Op Code Map after 1FH

AC Characteristics

The section provides information about the AC characteristics and timing. All AC timing information assumes a standard load of 50pF on all outputs.

Table 117. AC Characteristics

		V_{DD} = 2.7 to 3.6V T_A = 0°C to +70°C		V_{DD} = 2.7 to 3.6V T_A = –40°C to +105°C			
Symbol	**Parameter**	**Min**	**Max**	**Min**	**Max**	**Units**	**Conditions**
F_{SYSCLK}	System Clock Frequency			–	20.0	MHz	Read-only from Flash memory
				0.032768	20.0	MHz	Program or erasure of the Flash memory
F_{XTAL}	Crystal Oscillator Frequency			1.0	20.0	MHz	System clock frequencies below the crystal oscillator minimum require an external
F_{IPO}	Internal Precision Oscillator Frequency			0.032768	5.5296	MHz	Oscillator is **not** adjustable over the entire range. User may select Min or Max value only.
F_{IPO}	Internal Precision Oscillator Frequency			5.31	5.75	MHz	High speed with trimming
F_{IPO}	Internal Precision Oscillator Frequency			4.15	6.91	MHz	High speed without trimming
F_{IPO}	Internal Precision Oscillator Frequency			30.7	33.3	KHz	Low speed with trimming
F_{IPO}	Internal Precision Oscillator Frequency			24	40	KHz	Low speed without trimming
T_{XIN}	System Clock Period			50	–	ns	$T_{CLK} = 1/F_{sysclk}$
T_{XINH}	System Clock High Time			20	30	ns	T_{CLK} = 50 ns
T_{XINL}	System Clock Low Time			20	30	ns	T_{CLK} = 50 ns

Appendix A. Register Tables

For the reader's convenience, this appendix lists all F0830 Series registers numerically by hexadecimal address.

General Purpose RAM

In the F0830 Series, the 000–EFF hexadecimal address range is partitioned for general-purpose random access memory, as follows.

Hex Addresses: 000–0FF

This address range is reserved for general-purpose register file RAM. For more details, see the Register File section on page 14.

Hex Addresses: 100–EFF

This address range is reserved.

Timer 0

For more information about these Timer Control registers, see the Timer Control Register Definitions section on page 83.

Hex Address: F00

Table 130. Timer 0 High Byte Register (T0H)

Bit	7	6	5	4	3	2	1	0
Field	TH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F00H							

Hex Address: F05

Table 135. Timer 0 PWM Low Byte Register (T0PWML)

Bit	7	6	5	4	3	2	1	0
Field	PWML							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F05H							

Hex Address: F06

Table 136. Timer 0 Control Register 0 (T0CTL0)

Bit	7	6	5	4	3	2	1	0
Field	TMODEHI	TICONFIG		Reserved	PWMD			INPCAP
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F06H							

Hex Address: F07

Table 137. Timer 0 Control Register 1 (T0CTL1)

Bit	7	6	5	4	3	2	1	0
Field	TEN	TPOL	PRES			TMODE		
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F07H							

Hex Address: F08

Table 138. Timer 1 High Byte Register (T1H)

Bit	7	6	5	4	3	2	1	0
Field	TH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F08H							

Hex Addresses: F87–F8F

This address range is reserved.

Comparator 0

For more information about the Comparator Register, see the Comparator Control Register Definitions section on page 107.

Hex Address: F90

Table 156. Comparator Control Register (CMP0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	INNSEL	REFLVL				Reserved	
RESET	0	0	0	1	0	1	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F90H							

Hex Addresses: F91–FBF

This address range is reserved.

Interrupt Controller

For more information about the Interrupt Control registers, see the Interrupt Control Register Definitions section on page 57.

Hex Address: FC0

Table 157. Interrupt Request 0 Register (IRQ0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	T1I	T0I	Reserved	Reserved	Reserved	Reserved	ADCI
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC0H							

Hex Address: FC5

Table 162. IRQ1 Enable Low Bit Register (IRQ1ENL)

Bit	7	6	5	4	3	2	1	0
Field	PA7ENL	PA6CENL	PA5ENL	PA4ENL	PA3ENL	PA2ENL	PA1ENL	PA0ENL
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC5H							

Hex Address: FC6

Table 163. Interrupt Request 2 Register (IRQ2)

Bit	7	6	5	4	3	2	1	0
Field	Reserved				PC3I	PC2I	PC1I	PC0I
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC6H							

Hex Address: FC7

Table 164. IRQ2 Enable High Bit Register (IRQ2ENH)

Bit	7	6	5	4	3	2	1	0
Field	Reserved				C3ENH	C2ENH	C1ENH	C0ENH
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC7H							

Hex Address: FC8

Table 165. IRQ2 Enable Low Bit Register (IRQ2ENL)

Bit	7	6	5	4	3	2	1	0
Field	Reserved				C3ENL	C2ENL	C1ENL	C0ENL
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC8H							

J

L

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